



Detectors and Physics in Higgs factories

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Most slides are from ILC-J collaboration task force meeting on 21st January

Contents

- Physics for Higgs factories
- Basic design of detectors and key technologies
- Key performances issues and related technologies
 - Particle flow and jet energy reconstruction
 - Tracking performance
 - Particle ID / Flavor tagging

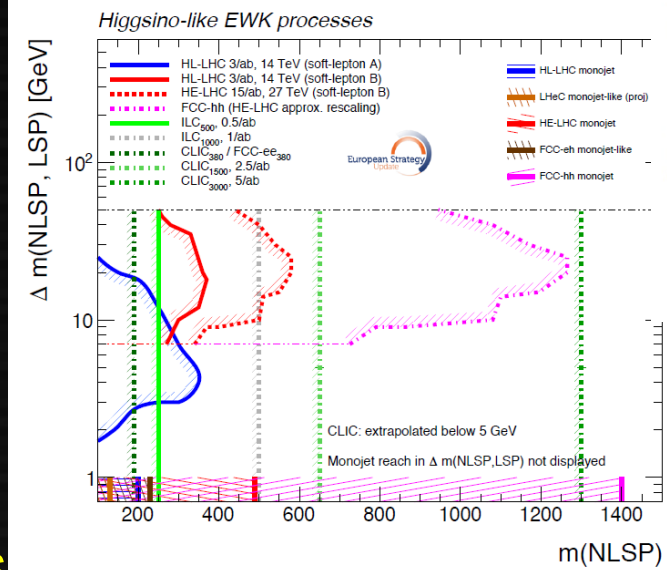
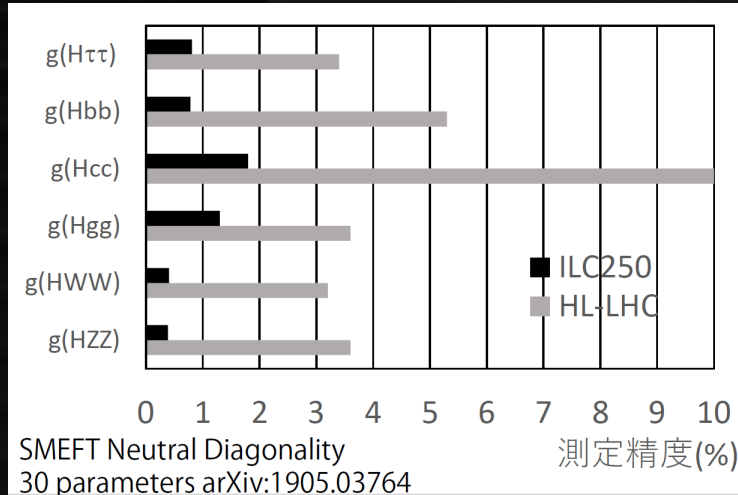
Physics for (Linear) Higgs factories

TeV-scale new physics

- Extended Higgs sector (SUSY, composite Higgs, ...)
 - Higgs couplings, SMEFT
- Direct search (SUSY, ...)
 - Compressed spectrum
 - Mono-photon for WIMP
 - Long-lived etc.
- Indirect search (Z' , WIMP, ...)

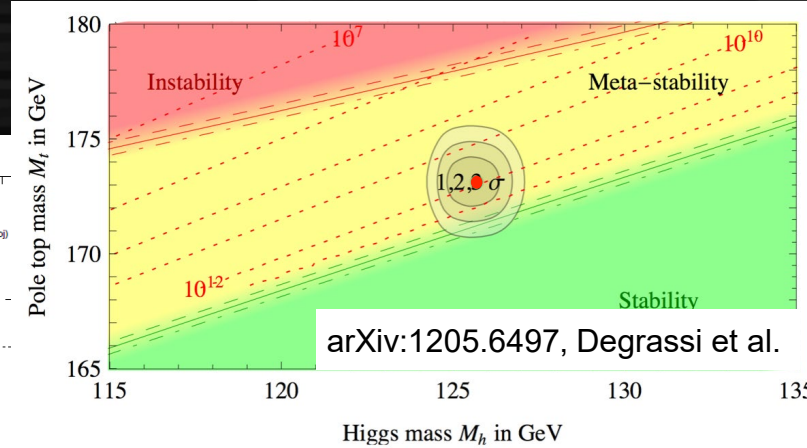
Light new physics

- Higgs portal DM
 - Invisible/exotic decay of Higgs
- ALPs, dark photons, heavy stables
 - Fixed target, off-axis detectors



Vacuum and spacetime

- Higgs/top mass
- Higgs self coupling
- Higgs CP mixture



See JPS talk for details

<https://kds.kek.jp/event/43097/contributions/222056/attachments/159589/204754/10pS1-04.pdf>

Physics and Reconstruction performance

TeV-scale new physics

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Detector challenges

b/c tagging
strange tagging

Low-p tracking
Forward detectors

Timing

Quark charge ID

Jet energy resolution

Vacuum and spacetime

Higgs/top mass

Momentum resolution
b tagging

Higgs self coupling

b tagging
Jet energy resolution(?)

Higgs CP mixture

Tau reconstruction
(track-photon separation)

Physics and Reconstruction performance

TeV-scale new physics

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Light new physics

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Software challenges

b/c tagging
strange tagging

Low-p track finding

Track finding

Quark charge ID

Jet energy resolution

Vacuum and spacetime

Higgs/top mass

b tagging

Higgs self coupling

b tagging

Jet clustering

Higgs CP mixture

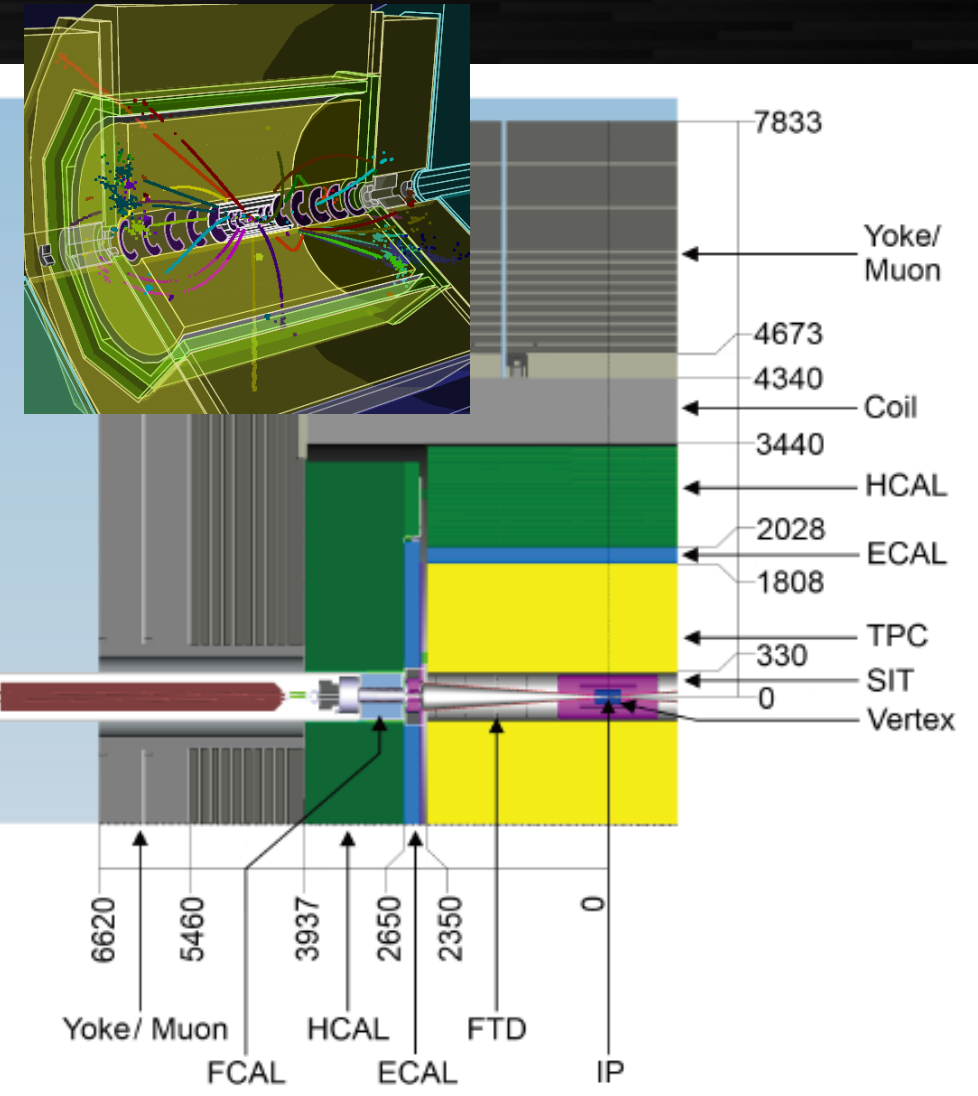
Tau reconstruction
(track-photon separation)

Interplay of hardware and software
critical for most of the reconstruction

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A reference design for Particle Flow detector (ILD)



Vertex, Silicon Inner Tracker (SIT), Forward tracker (FTD)

- Monolithic silicon pixels (or strips possible at SIT/FTD)
 - Various technologies proposed (CMOS, SOI, Fine Pixel CCD, ...)
- Point resolution of a few μm , 10^9 pixels & low material

Main tracker: Time Projection Chamber and Outer Silicon (SET)

- TPC: Continuous tracking & PID with dE/dx measurement
- SET: Silicon layer outside TPC, improving momentum resolution, optionally ToF measurement by picosec timing

High granular calorimeters (ECAL, HCAL)

- ECAL: Silicon or Scintillator, $\sim 2500 \text{ m}^2$
 - Silicon: pad ($5 \times 5 \text{ mm}^2$) or pixel ($50 \times 50 \mu\text{m}^2$, digital)
- HCAL: Scintillator or RPC, 1-3 cm cells

Superconducting solenoid (3.5-4 Tesla)

- Outside HCAL

Muon detector in Return yoke

Novel technologies: Two Big Waves

Picosec timing Target: 30 psec or less

Original interest for pileup rejection for HL-LHC

- **Various competitive sensor technologies**
 - Silicon – LGAD, SPAD, ...
 - Scintillator – SiPM, but photon collection time is important
 - Cherenkov – same as above
 - RPC or GasPM
- **Electronics**
 - Power consumption issue
 - Clock distribution (serious for <10 ps)
- **Industrial interest**
 - Distance measurement (ToF-PET, driving)
1.5 mm / 10 psec

Machine learning

Rapid development on image and language processing based on **Deep Neural Network**

- Convolutional Neural Network
- Recurrent Neural Network and Transformer/Attention tech.
- Generative network
- **Graph Neural Network**
- **Quantum machine learning**

Dedicated design necessary for optimized performance
→ more efforts need to be put on

Key performances (revisited)

- Jet energy resolution
 - Performance of particle flow
- Momentum resolution & low-p tracking
 - Precise tracking
- Particle ID & flavor tagging
 - Charged hadron ID ($\pi/K/p$)
 - dE/dx, TOF, RICH...
 - Quark flavor tagging
 - b-tag, c-tag, s-tag, (g-tag)
 - Quark charge ID

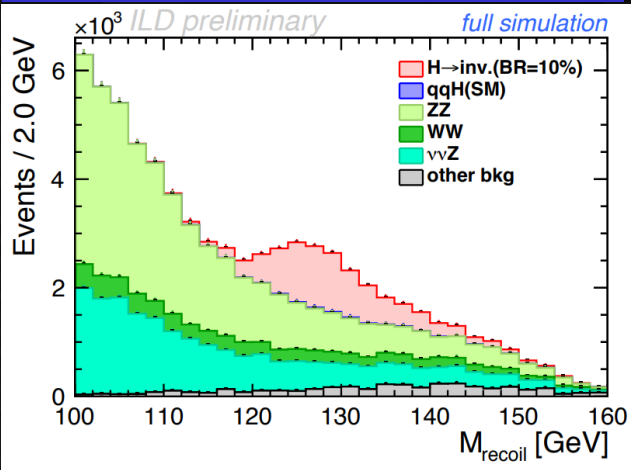
Possible impact
of new technologies

Picosec timing

Machine learning

Particle flow and granularity

Physics impact of jet energy resolution

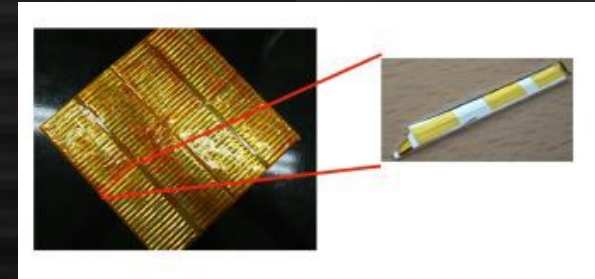


Medium-granular calorimeter (baseline)

Granularity: ~ 5 mm (silicon, scintillator)

Analog readout: requiring wide dynamic range (1-1000 MIP)

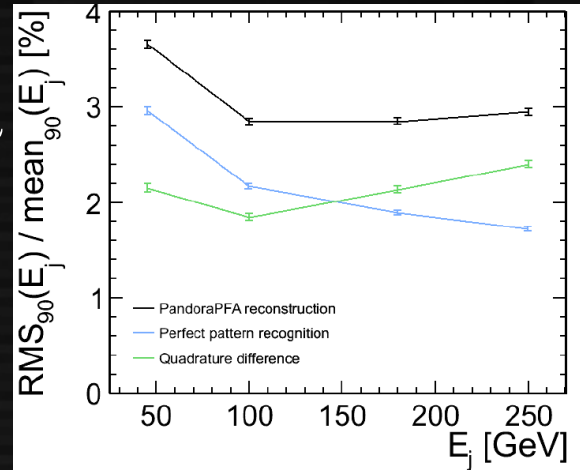
Mature concept, working on engineering issues on electronics and mechanics



Recoil mass of $ZH \rightarrow qq\chi\chi$
(Higgs invisible decay)

Higgs self coupling
($ZHH \rightarrow qqbbbb$)

Separation with other 6q final states
(eg. $ZZH \rightarrow qqbbbb$)



Confusion dominates at higher energies

Ultra-granular calorimeter (advanced)

Granularity: < 100 μm (monolithic pixel)

Digital readout with integrated electronics
(or semi-digital better for higher energy?)

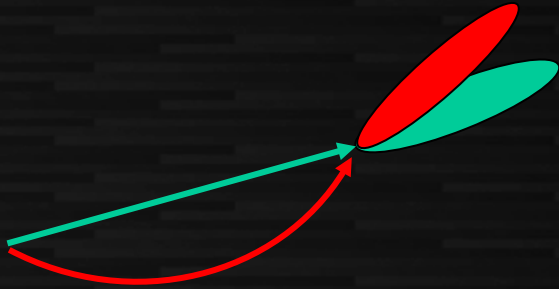
Large-area sensors (with low cost)

to be implemented and demonstrated

Particle flow and new technologies

Picosec timing

5-dimensional clustering



Timing resolution of EM cluster can be > 10 times higher than MIP thanks to averaging (intelligent pattern recognition necessary)

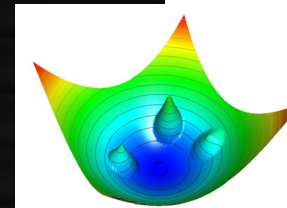
Machine learning

- Current PFA is human-tuned → dependence on detector performance difficult to be seen
- 5D clustering with timing information
- Better performance for physics

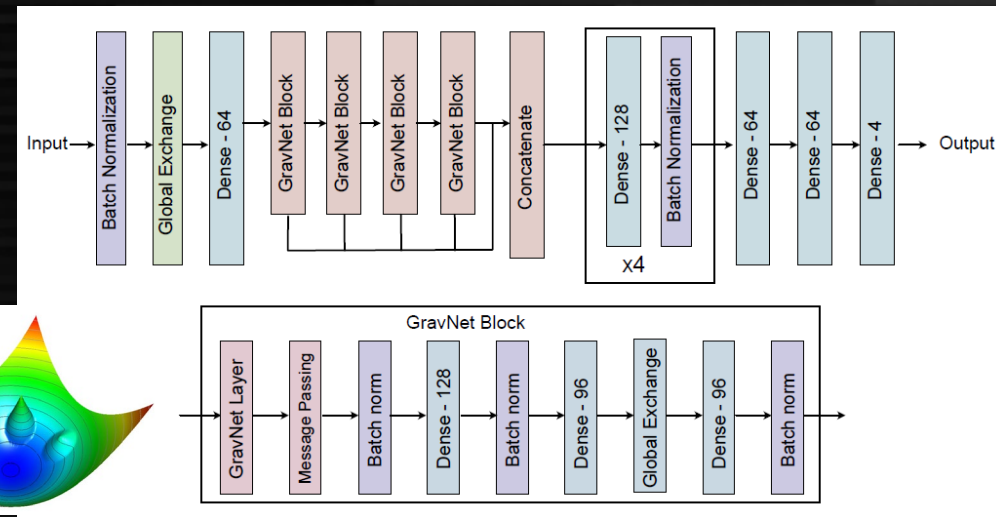
Timing difference on charged and neutral clusters



Loss function



< 10 psec cluster resolution preferred



CMS HGCal algorithm

Now trying to apply to ILC simulation

Tracking-related performance

Physics impact of tracking

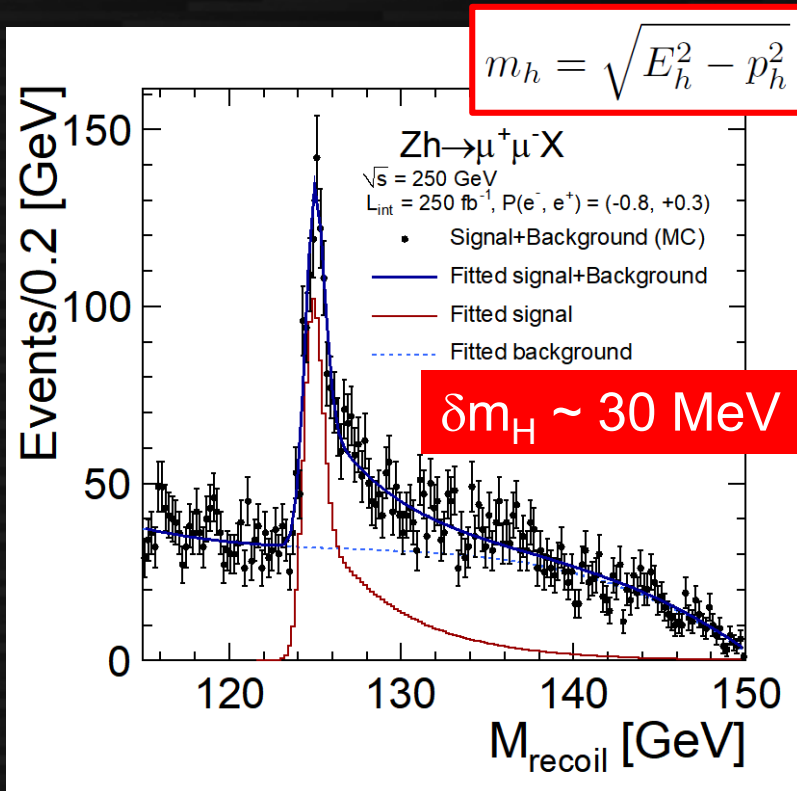
- Momentum resolution
 - Higgs recoil mass
- Low energy tracking
 - Low mass splitting BSM etc.

Silicon tracking

- **Better point resolution (a few μm)**
- **Better timing**
- Small hit points: discrete tracking

Gas tracking (TPC)

- Worse point resolution (60-100 μm in ILD)
- No timing
- **Continuous tracking stronger for low-p**
- **dE/dx capability**



Extreme position resolution with thin silicon

- Multiple scattering effectively limits momentum reso
- Ultra-thin ($O(10 \mu\text{m})$) sensor possible with LGAD/SPAD techniques (thanks to gain) \rightarrow realizing sub- μm (or even 100 nm) resolution?
- Can improve resolution or realize smaller tracker?

Charged hadron ID (track mass measurement)

Impact of hadron ID / track mass

- Strange tagging (p/K/ π separation)
 - $H \rightarrow ss$
 - EW form factor, Z'/WIMP
- b/c tagging (through s-tag) / charge
 - Reconstructing full decay chain
- Jet energy resolution (PFA)
 - Assign correct mass to tracks
- Heavy track (BSM)

Detailed studies for physics impact has not fully done yet.

How to perform hadron ID

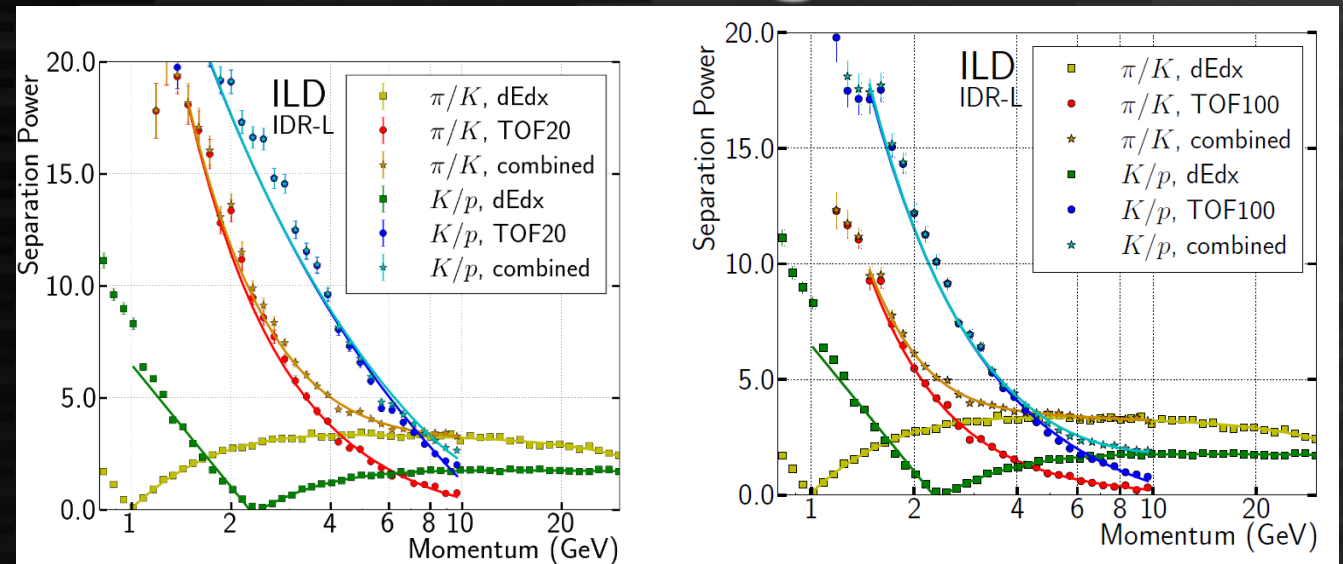
- **dE/dx at tracker (TPC)**
 - Moderate separation up to tens of GeV
 - Ineffective region at a few GeV
 - Better separation with pixel readout expected
- **Time of Flight (ToF)** (details on next page)
 - Good to cover the few GeV region (with O(100 psec))
 - O(10psec) can cover up to 5-10 GeV (not fully compensating dE/dx with TPC)
- **Ring-imaging Cherenkov (RICH)**
 - To be placed between tracker and calo
 - Being considered in SiD

Hadron ID and new technologies

Picosec timing

Time-of-flight at calo or tracker

- Outer tracker (silicon)
 - Fewer hits to average (require better MIP reso)
 - Capacitance of strips
 - No power on neutrals
- Calorimeter
 - **Many hits to average** (better)
 - Need intelligent algorithm (to remove slow hits)
 - Small pixel for capacitance → problem of electronics
 - Maybe not realistic for implementation of full layers



Significance of p/K/p separation
TOF by calorimeter hits (~10 hits averaged)

Machine learning

Necessary for timing reconstruction at calo
DNN PFA can output timing information as well

ML is less important for ToF of trackers

Quark flavor tagging

Impact of flavor tagging

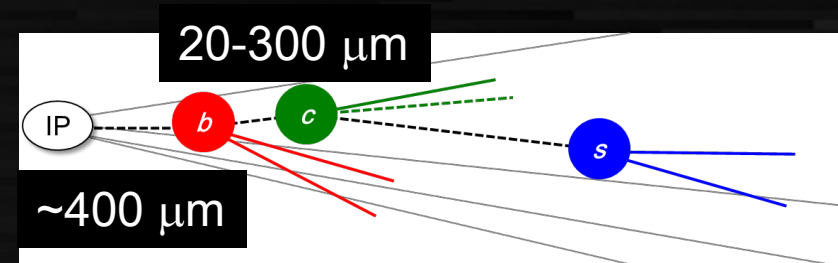
- Higgs couplings (Hbb , Hcc , Hgg)
 - c-tag especially important
- Higgs self coupling (ZHH)
 - Separation of tt background
- EW precision ($2f$, triple coupling)
- Exotic Higgs decay
 - eg. $H \rightarrow \phi\phi \rightarrow 4b / 2b2\chi$
- Various BSM models

Decay mode of ZHH	BR.	# events in 4 ab^{-1}
qqbbbb	22%	176
vvbbbb	7%	56
llbbbb	3%	24
$tt \rightarrow bbqqqq$		$\sim 1,000,000$
$ZZZ, ZZ\gamma, ZZH \rightarrow qqbbbb$		$\sim 1,000$

Statistics of self coupling analysis

Hardware for flavor tagging

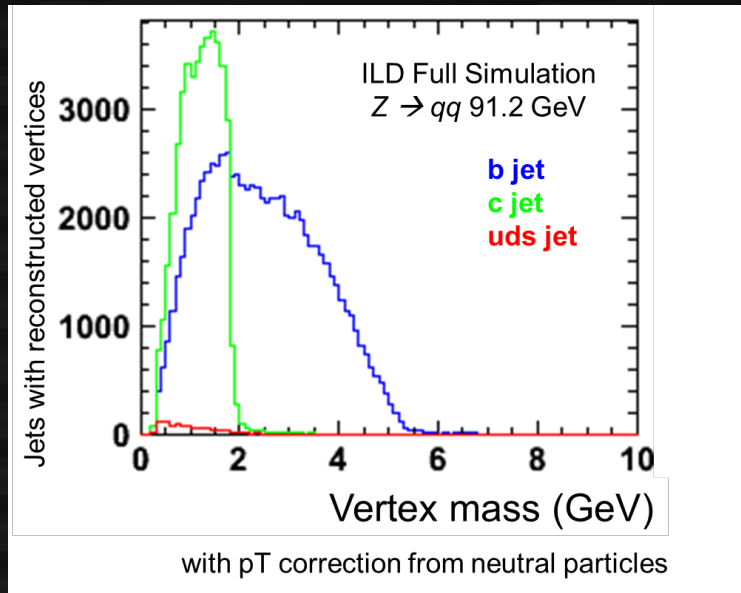
- Vertex detector
 - 15 – 60 mm from IP
 - limited by pair background
 - A few μm resolution is more than enough for b-tag, can be smaller for c-tag
 - So smaller resolution only improves c-tag
- Particle (Kaon) ID
 - Can help reconstructing decay chain but software needs to be improved
- Off-IP photons by timing (next page)



Flavor tagging and new technologies

Picosec timing

- Identifying π^0 from secondary vertices
 - 1 psec = 0.3 mm for photons
 - 30 psec/MIP & 1000 MIP averaged to obtain 1 psec: ultimate goal



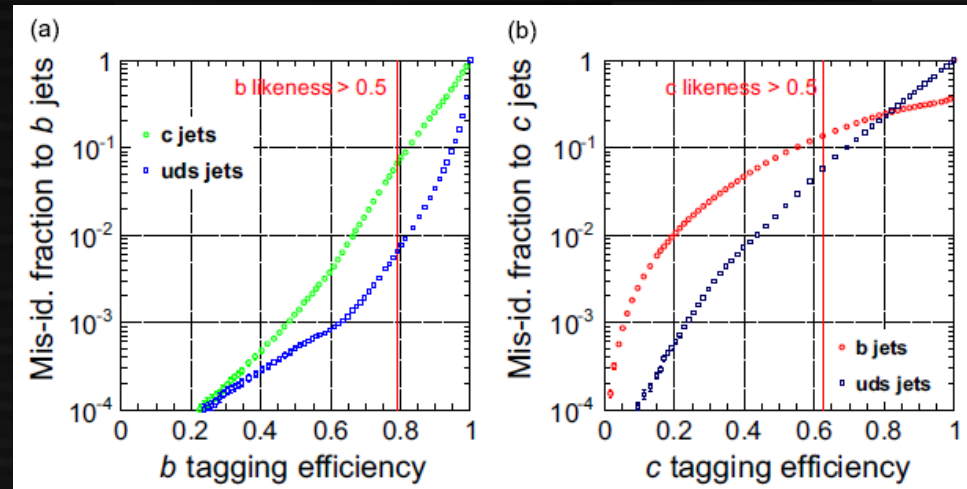
Vertex mass gives square distribution with charged particle only: should be peaky with neutrals

Machine learning

- Current algorithm (LCFIPlus)
- Vertex finding (cut-based)
 - Jet clustering (pairing)
 - Flavor tagging (BDT)



Single DNN process with combined function?
Now trying graph neural network



LCFIPlus performance

Summary

- Physics performance depends on detector and software
 - Quark/lepton ID, jet energy/clustering, tracking, ...
 - Sometimes not so clear, strongly dependent on analysis/software
- New technologies: timing and (deep) machine learning
 - Many cases to (possibly) improve the physics performance
 - But may not be a game changer (up to now...)
 - Innovative ideas very welcome! Please consider or do brainstorming
- Wider collaboration is desirable!

Backup

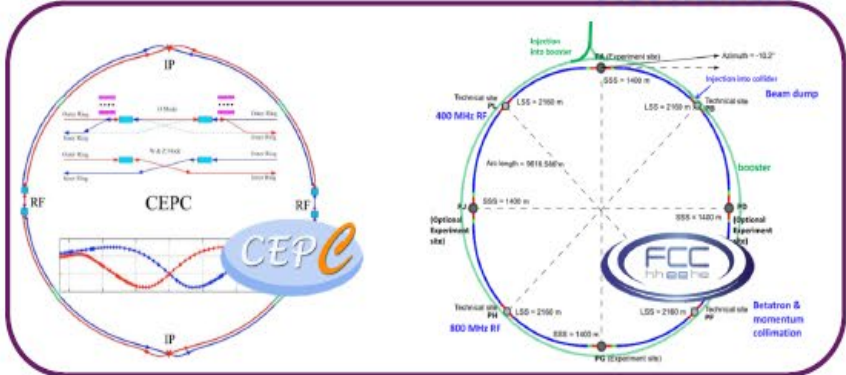
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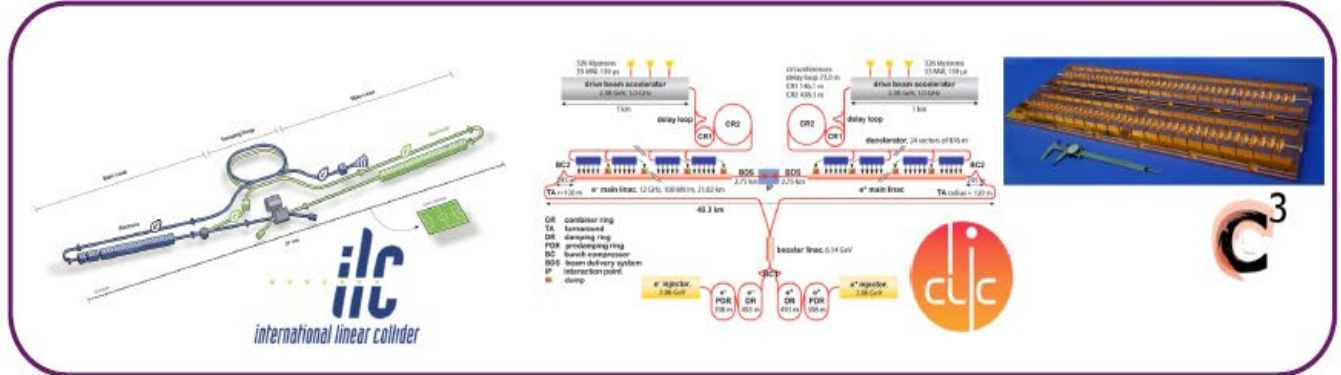
Detectors for Higgs factories

e+e- colliders

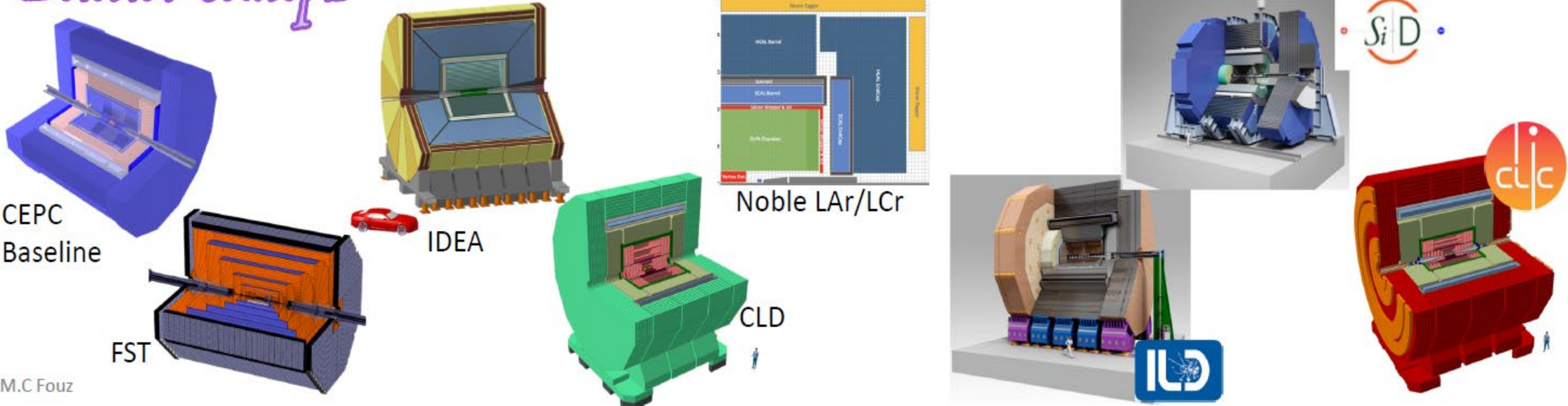
Circular



Linear



Detector Concepts

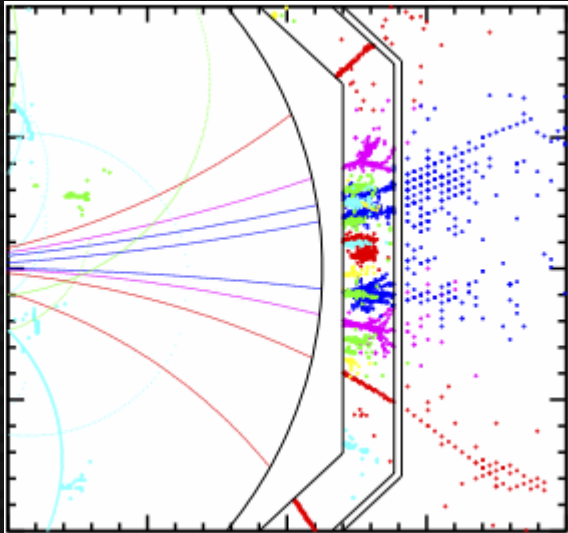


M.C Fouz

HF detector: particle flow vs dual readout

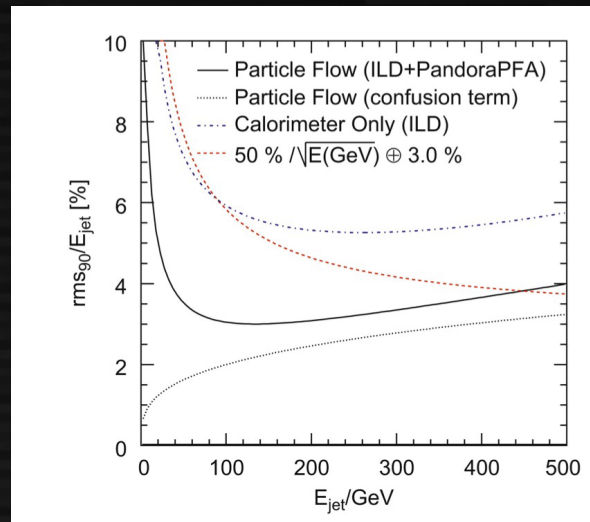
Particle flow

ILD, SiD, CLIC, CLD, CEPC, FST, LAr(?)



Separate particles in jets
with **high-granular calorimeter**
Large B field and **big detector**
for better separation of particles
Solenoid outside hadron calorimeter

2x better jet energy
resolution compared to
traditional calorimetry
More information on
jet substructure
→ ML-friendly info



Dual readout

IDEA (for FCCee/CEPC), 4th (for ILC)

Concurrent acquisition
of scintillator and Cherenkov

- Scintillator → energy dep.
- Cherenkov → # particles

Separate hadronic and
electromagnetic component
of shower by the ratio of 2

Smaller detector possible
because of no need of
separating jet particles

Key detector elements: Silicon sensors

Common key advantages

- Small pixels **without physically-divided sensors** (cf. assembly of small scintillators)
- Intrinsic **integration with electronics** (ie. Monolithic sensors)
- **Good intrinsic resolution** of energy deposit (3.6 eV/e-h pair)
- Relatively **low material** (disadvantage for calorimetry though)

Monolithic sensors

For vertex detector / inner tracker

- < 25 μm sensor cells, 50 μm thick for point resolution of a few μm
- Fast readout (>20 readout / 1ms)
- Low power consumption

For outer tracker / calorimeter

- Large area (100m² for outer tracker, ~2000 m² for ECAL)
- Low dead area with big sensors are one of the big issues of development
- Picosec timing? (impossible with plain CMOS)

Strip sensors (hybrid)

For main/outer tracker

- 25 μm pitch, 7 μm reso (in current ILD design)
- Or extreme resolution of 0.1-1 μm ?

Pad sensors (hybrid)

For calorimeter

- 5 x 5 mm² cells, 10⁸ ch
- 2500 m², cost sensitive
- Electronics & cooling

Multiple technologies
Wide applications
on vertex, tracker,
calorimeter

Picosec timing

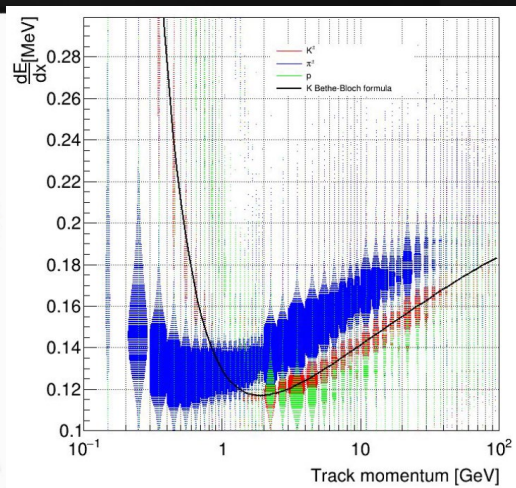
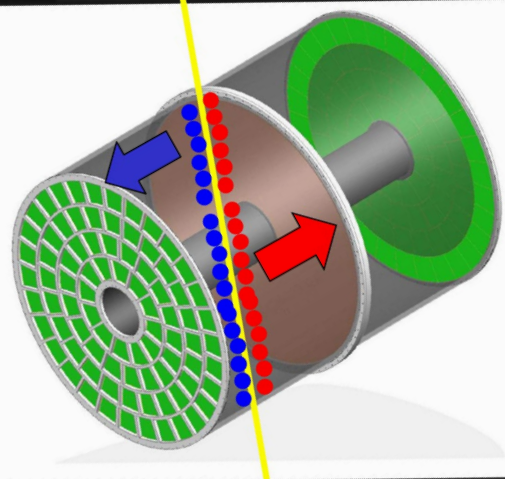
For outer tracker/calorimeter

- Standard LGAD: ~30 psec
- New technologies
 - Thinner LGAD
 - Monolithic LGAD
 - SPAD
- Issues on electronics

Key detector elements: Gas & Optical sensors

Time Projection Chamber

- **Continuous tracking** by gas
 - 2D position at pad sensors
 - Z position by drifting time
- MPGD (GEM/Micromegas) for amplification
- **dE/dx for particle ID**
 - Better with cluster counting with **silicon pixel** instead of pads
 - connection to **silicon sensor R&D**



Optical calorimeter

- Finely-segmented scintillator strips or tiles with SiPMs for ECAL/HCAL
 - ECAL: crossing strips to realize effectively fine segmentation with smaller # of sensors
- Timing with **SiPMs** – **similar technology to SPAD silicon sensor**
- Essentially cheaper than silicon pads but more on assembly and calibration
- Options: **adding Cherenkov absorber** while maintaining fine segmentation (PFA + dual-readout)

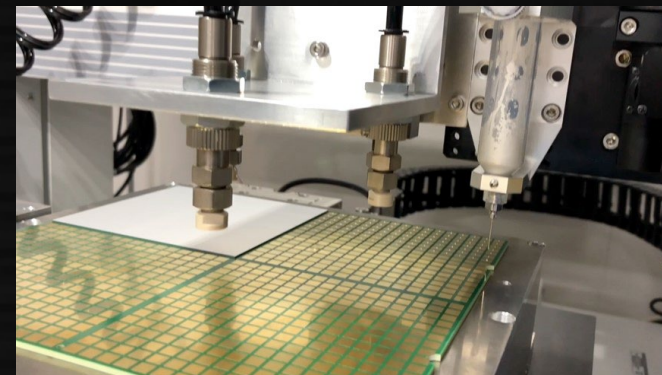
Key detector elements: electronics & mechanics

Readout electronics

- **Frontend electronics**
 - **readout ASIC**
 - Analog/digital combined
 - Power pulsing
millisec (for trains) demonstrated
nanosec (for bunches) possible?
 - Smaller design rules
→ more professional effort
on development (not easy to contribute)
- **Backend & DAQ**
 - Large-scale design for full detector
not seriously discussed yet
→ room for contributions!

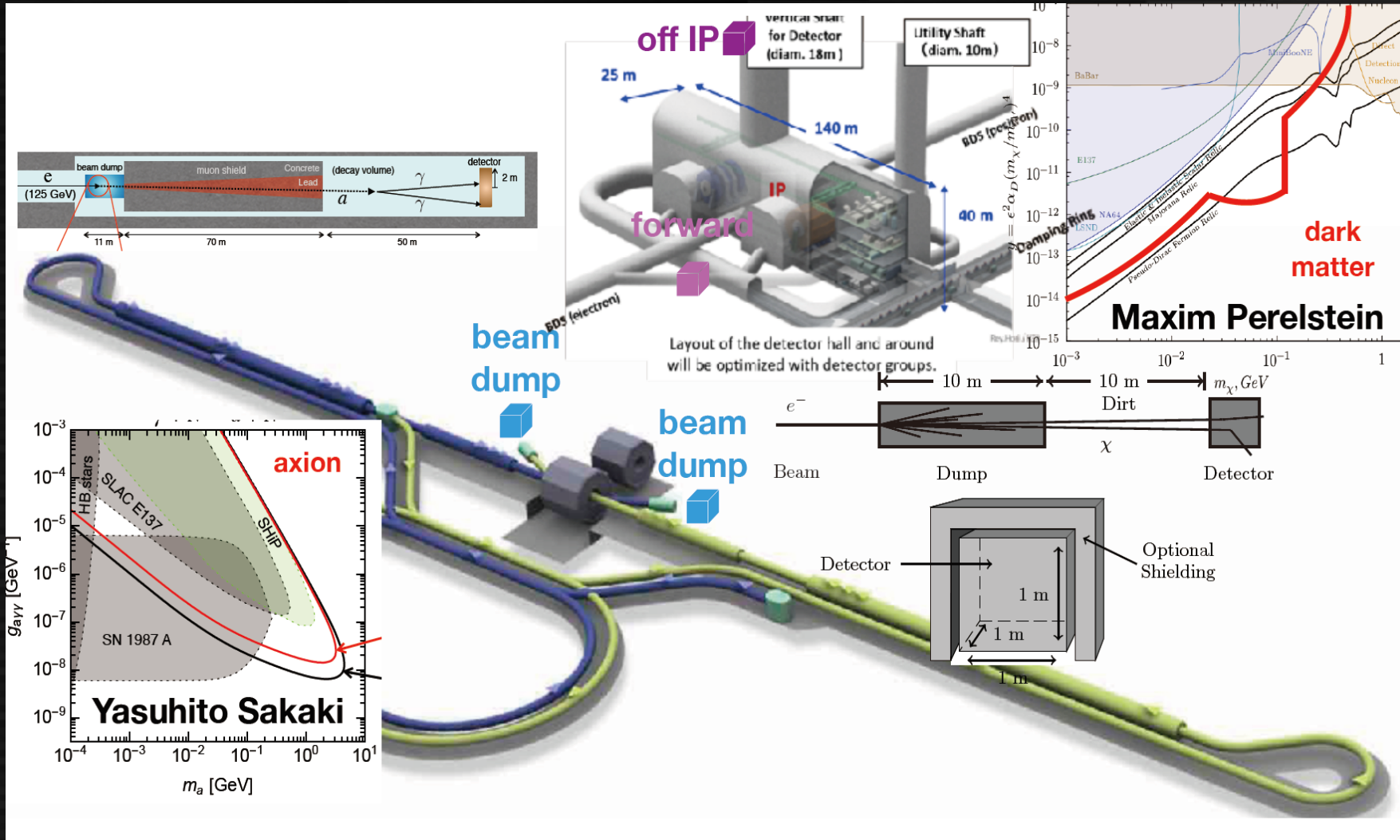
Assembly / Mechanics

- Assembly method for module
 - Assembly of sensors (esp. optical)
 - Interconnection of sensor/electronics
(eg. silicon – WB, BB, ACF, glue, ...)
 - Automatic assembly (robots, AI)
- Mechanical design
(low material, stable, precise)
- Quality control / assurance etc.



Gluing
silicon pads
to frontend

Appendix: Off-IP detectors



Fixed-target experiments are also important for application of HF detector technology eg.) KEK Linac beam dump experiment (EBES)

T. Izawa, A. Ishikawa, H. Iwase, H. Oide, F. Miyahara, Y. Morikawa, Y. Sakaki, Y. Takubo, S. Higashino, H. Otono, T. Suehara, K. Yoshihara, S. Tsumura

Welcoming various ideas on detectors at beam dump and off-IP

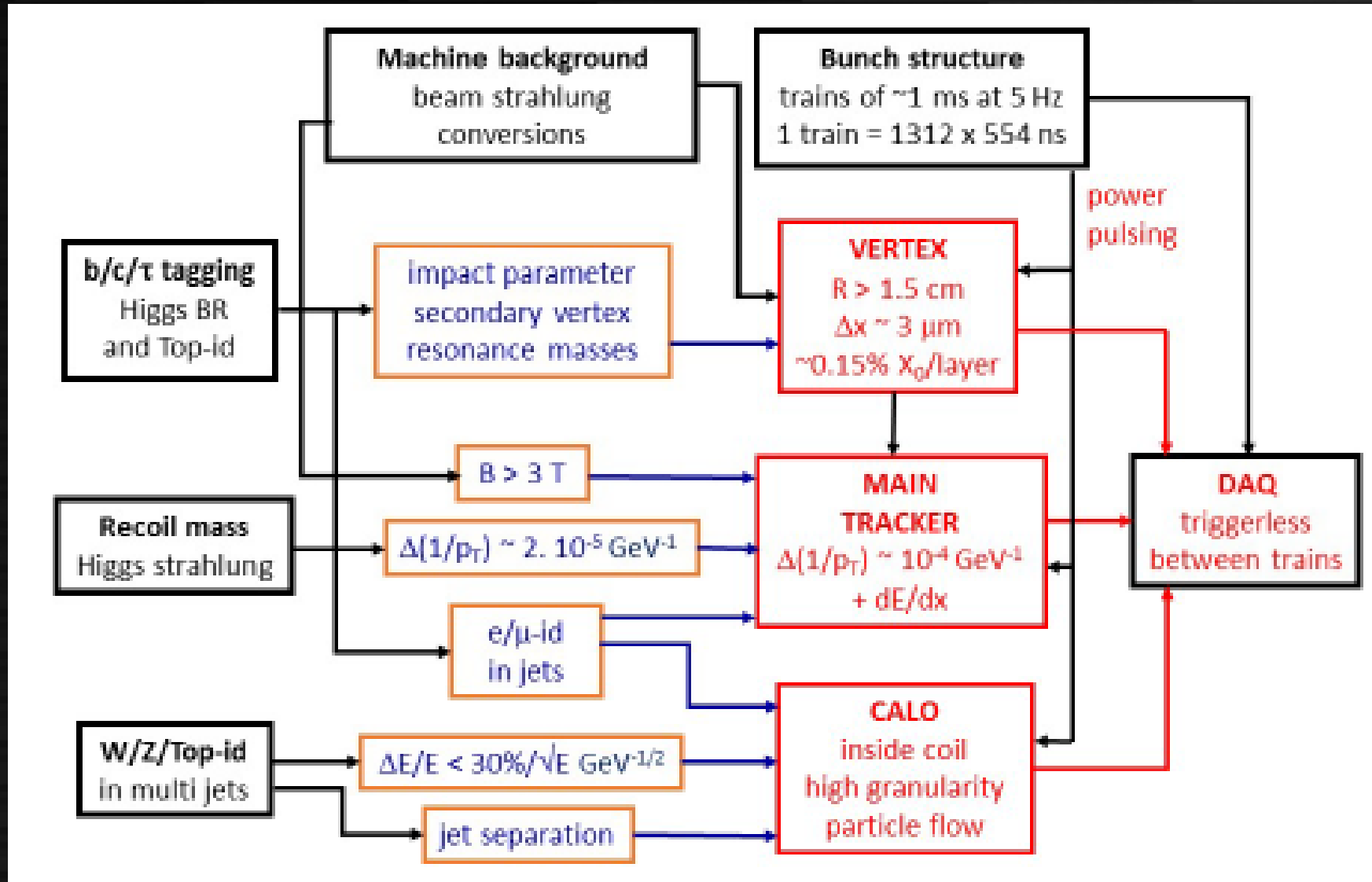
High-granular calorimeter for 2-photon separation

Final remarks

- Detector development has stages
 1. Proof-of-concept of novel ideas
 2. **Conceptual demonstration of emerging technologies**
 - **Recent interest: pico-sec timing and machine learning**
 3. Engineering design and prototyping of proven technologies
 - Many remaining issues on sensors, electronics, mechanics for each detector (pixel, tracker, calorimeter)
 4. Real construction
- We should pursue better performance with emerging technologies while getting ready for construction with proven technologies
 - Both are important and attractive targets!
- Let's discuss and work for the next-generation collider detectors!

Today's focus

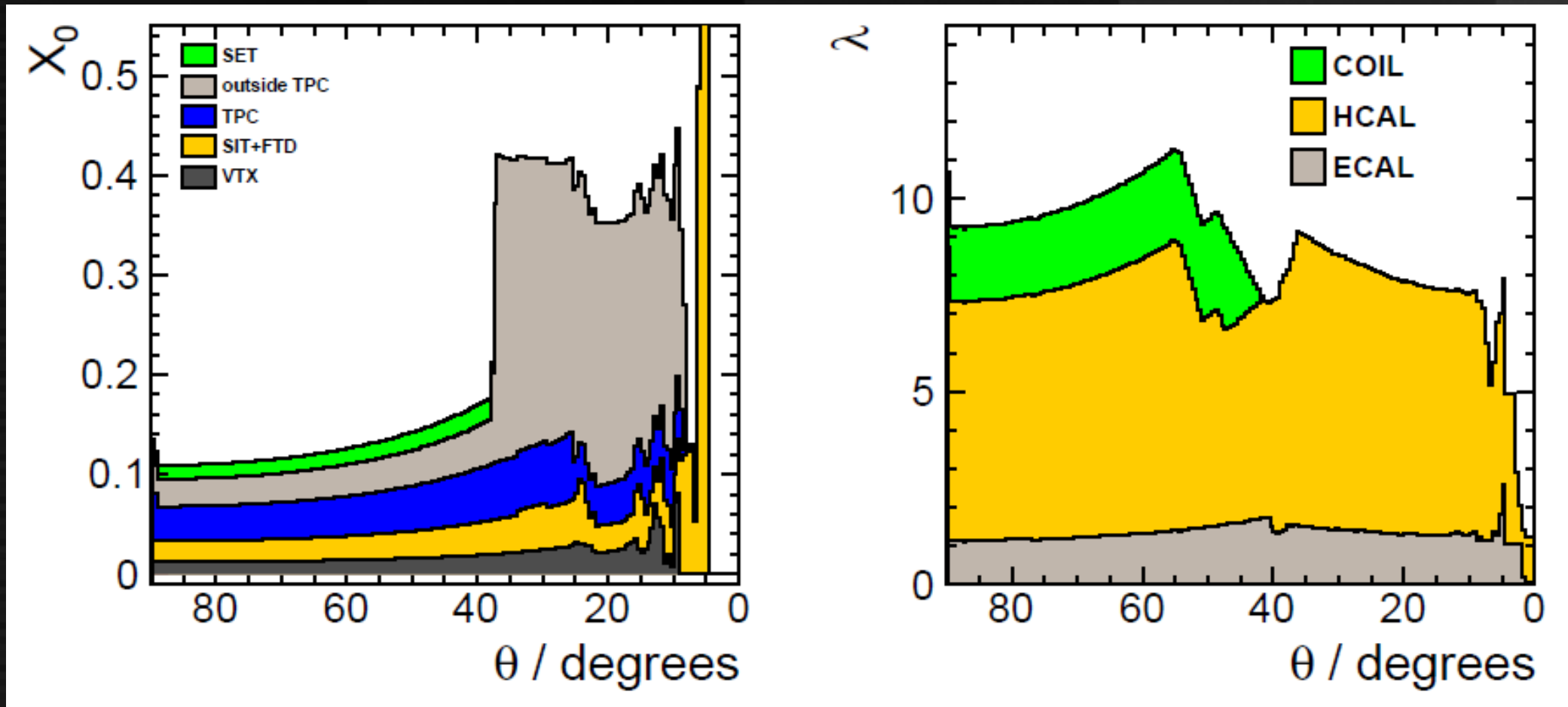
ILD performance requirements



ILD specifications

Barrel system							End cap system							
System	r_{in}	r_{out} [mm]	z_{max}	technology	comments		System	z_{min}	z_{max}	r_{in}	r_{out}	technology	comments	
VTX	16	60	125	silicon pixel sensors	3 double layers at $\sigma_{r\phi,z} = 3.0 \mu\text{m}$ $\sigma_t = 2\text{-}4 \mu\text{s}$	$r_0 = 16, 37, 58 \text{ mm}$ (layers 1-6)	FTD	220 645	371 2212		153 300	silicon pixel sensors silicon strip sensors	2 discs 5 double discs	$\sigma_{r\phi,z} = 3.0 \mu\text{m}$ $\sigma_{r\phi} = 7.0 \mu\text{m}$ $\phi_{stereo} = 7^\circ$
SIT	153	303	644	silicon pixel sensors	2 double layers at $\sigma_{r\phi,z} = 5.0 \mu\text{m}$ $\sigma_t = 0.5\text{-}1 \mu\text{s}$	$r = 155, 301 \text{ mm}$ (layers 1-4)	ECAL	2411	2635	250	2096 1718 ^s	W absorber silicon sensor scintillator sensor	30 layers $5 \times 5 \text{ mm}^2$ cells $5 \times 45 \text{ mm}^2$ strips	incl. EcalPlug SiECAL ScECAL
TPC	329	1770 1427 ^s	2350	MPGD readout	220 (163 ^s) layers $1 \times 6 \text{ mm}^2$ pads	$\sigma_{r\phi} \approx 60\text{-}100 \mu\text{m}$	HCAL	2650	3937	350	3226 2876 ^s	Fe absorber scintillator sensor, analogue	48 layers $3 \times 3 \text{ cm}^2$ cells	AHCAL
SET	1773 1430 ^s	1776 1433 ^s	2300	silicon strip sensors	1 double layer at $\sigma_{r\phi} = 7.0 \mu\text{m}$	$r = 1774 \text{ mm}$ $\phi_{stereo} = 7^\circ$						RPC gas sensor, semi-digital	$1 \times 1 \text{ cm}^2$ cells	SDHCAL
ECAL	1805 1462 ^s	2028 1685 ^s	2350	W absorber	30 layers									
				silicon sensor scintillator sensor	$5 \times 5 \text{ mm}^2$ cells $5 \times 45 \text{ mm}^2$ strips	SiECAL ScECAL								
HCAL	2058 1715 ^s	3345 3002 ^s	2350	Fe absorber	48 layers		Muon	4072	6712	350	7716 7366 ^s	scintillator sensor	12 layers $3 \times 3 \text{ cm}^2$ cells	
				scintillator sensor, analogue RPC gas sensor, semi-digital	$3 \times 3 \text{ cm}^2$ cells $1 \times 1 \text{ cm}^2$ cells	AHCAL SDHCAL	BeamCAL	3115	3315	18	140	W absorber GaAs readout	30 layers	
Coil	3425 3082 ^s	4175 3832 ^s	3872		3.5 T field 4.0 T field ^s	int.lengths = 2λ	LumiCAL	2412	2541	84	194	W absorber silicon sensor	30 layers	
Muon	4450 4107 ^s	7755 7412 ^s	4047	scintillator sensor	14 layers $3 \times 3 \text{ cm}^2$ cells		LHCAL	2680	3160	130	315	W absorber		

Material (ILD)

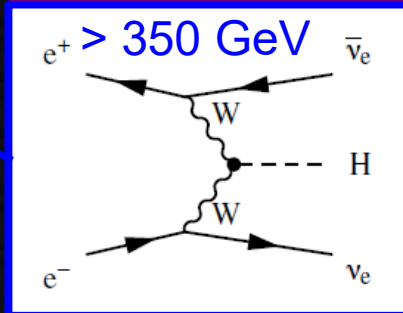
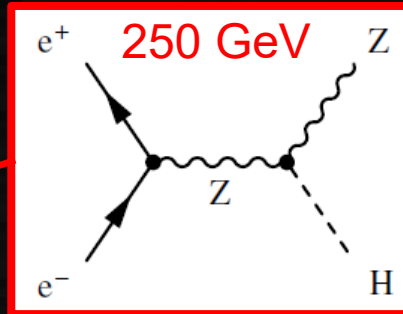
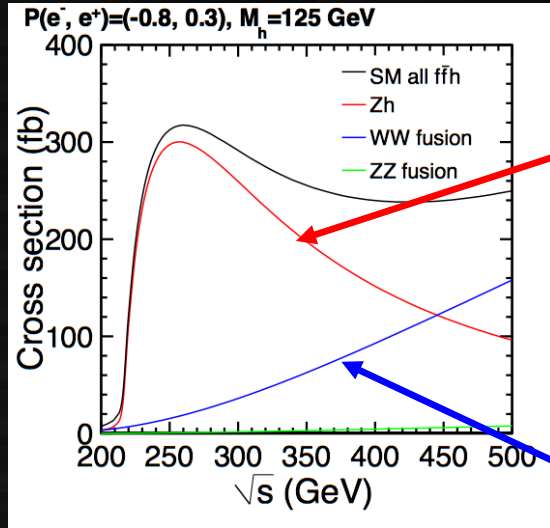


Timing resolution factors

Timing resolution factors: $\sigma_t^2 = \sigma_s^2 + \sigma_n^2$

- σ_s^2 : Uncertainty in the timing response of the sensor itself
 - **Landau noise**: waveform changes depending on whether energy deposit occurs more on the upper side or lower side of the sensor.
 - Making the sensitivity layer thinner decrease Landau noise, but the signal becomes smaller, so the S/N ratio becomes worse.
(It seem that the thickness of sensitive layer of S8664-50K is $5 \mu m$)
 - **Avalanche amplification fluctuation**: Uncertainty in time for accelerated electrons to knock out surrounding electrons
- σ_n^2 : Uncertainty caused by noise
 - **Capacitance of sensor**: The smaller the capacitance of the sensor, the smaller the rise time of the waveform.
 - Capacitance is proportional to the size of the sensor → Smaller sensors are less affected by noise.
 - **Thermal noise**: caused by high temperatures in amplifiers and sensor → need cooling
 - **Noise due to disturbance** to the conduction path between the sensor and the amplifier or due to HV
 - devise wiring, Stabilization of supply voltage, etc...

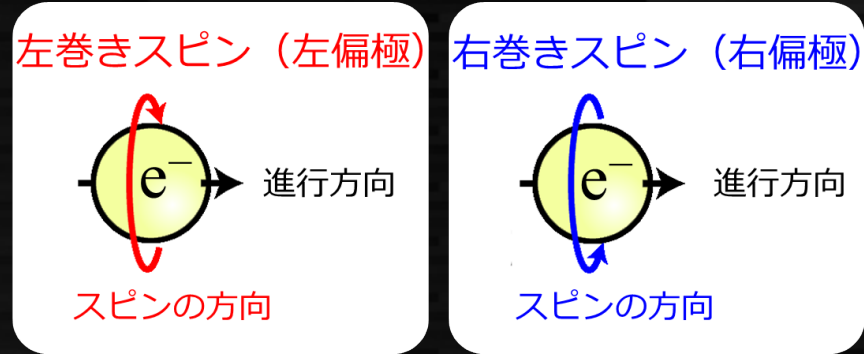
ヒッグス生成@ILC



$$N_{\text{detected}} = \epsilon \sigma \mathcal{L}_{\text{int}}$$

\mathcal{L}_{int} は積分ルミノシティ
 ILC 250 GeVでは
 2 ab^{-1} を想定
 (eLpR, eRpLを0.9 ab^{-1} ずつ)
 ϵ はほぼ100%。ただし
 背景事象を選ぶ過程で
 信号事象も一部が失われる
 (解析手法による)

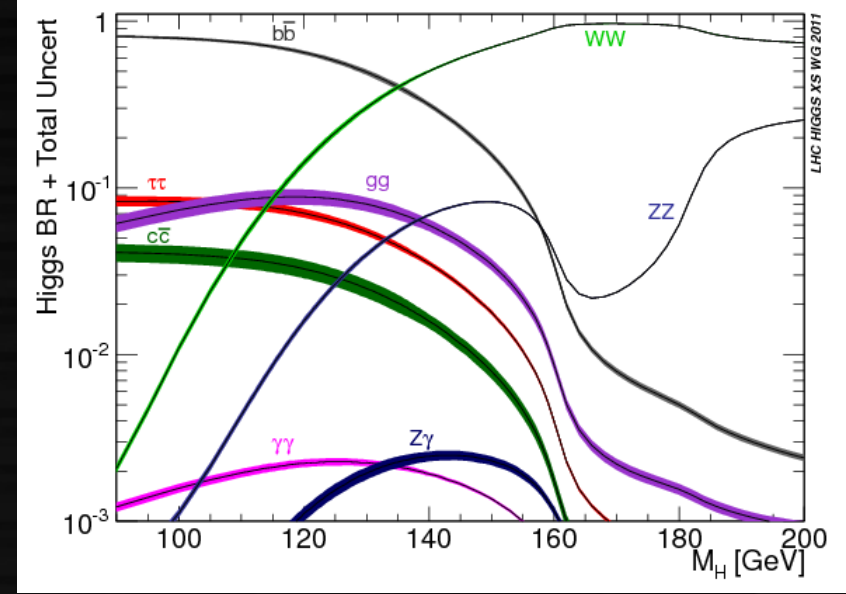
250 GeVでは $e^+e^- \rightarrow ZH$ が重要
 断面積は電子・陽電子偏極にもよる
 電子左偏極、陽電子右偏極(eLpR)
 が最も生成断面積が大きい。
 (eRpLで約6割程度)
 $0.9 \times 300 \times (1+0.6) = 432,000$ 事象
 200日x5年走るとして、432/day



ヒッグスの崩壊

- 生成したヒッグス粒子は即座に崩壊する
 - ヒッグスは電荷もバリオン・レプトン数も持たないので粒子・反粒子ペアに崩壊
 - ヒッグス粒子の結合は質量の2乗に比例
 - 重い粒子に壊れやすい
 - ただしヒッグスの質量の $\frac{1}{2}$ を越えるとエネルギー保存を満たさないため確率は下がる (off-shell崩壊と呼ぶ)

崩壊モード	崩壊分岐比	ILC 事象数
bb	58.1%	290,000
WW	21.5%	110,000
gg	8.2%	41,000
$\tau\tau$	6.3%	32,000
cc	2.9%	15,000
ZZ	2.6%	13,000
$\gamma\gamma$	0.2%	1,000



ヒッグスの測定

崩壊モード	崩壊分岐比
bb	58.1%
WW	21.5%
gg	8.2%
$\tau\tau$	6.3%
cc	2.9%
ZZ	2.6%
$\gamma\gamma$	0.2%

- ヒッグスの崩壊生成物はさらに崩壊する

- b, c, gluon

- ハドロンジェット

- (多数のハドロンの束)

- $W \rightarrow qq$ (2/3), lv (1/3)

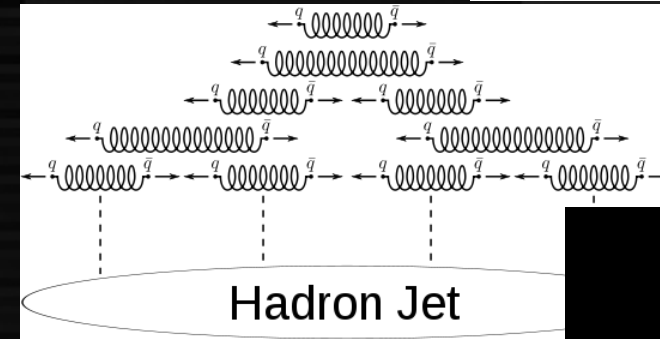
- $Z \rightarrow qq$ (70%), $\nu\nu$ (20%), $\mu\mu$ (10%)

- クォークはハドロンジェットになる

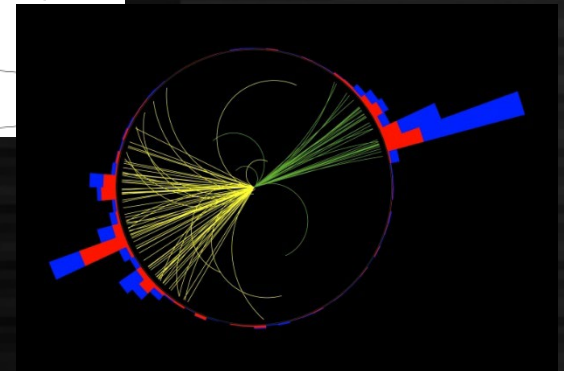
- $\tau \rightarrow$ 1~数個のハドロン/レプトンに崩壊 (tau jet)

- $\gamma \rightarrow$ 高エネルギー光子としてそのまま検出可能

- **ジェットやレプトンを測定器で検出する (後述)**

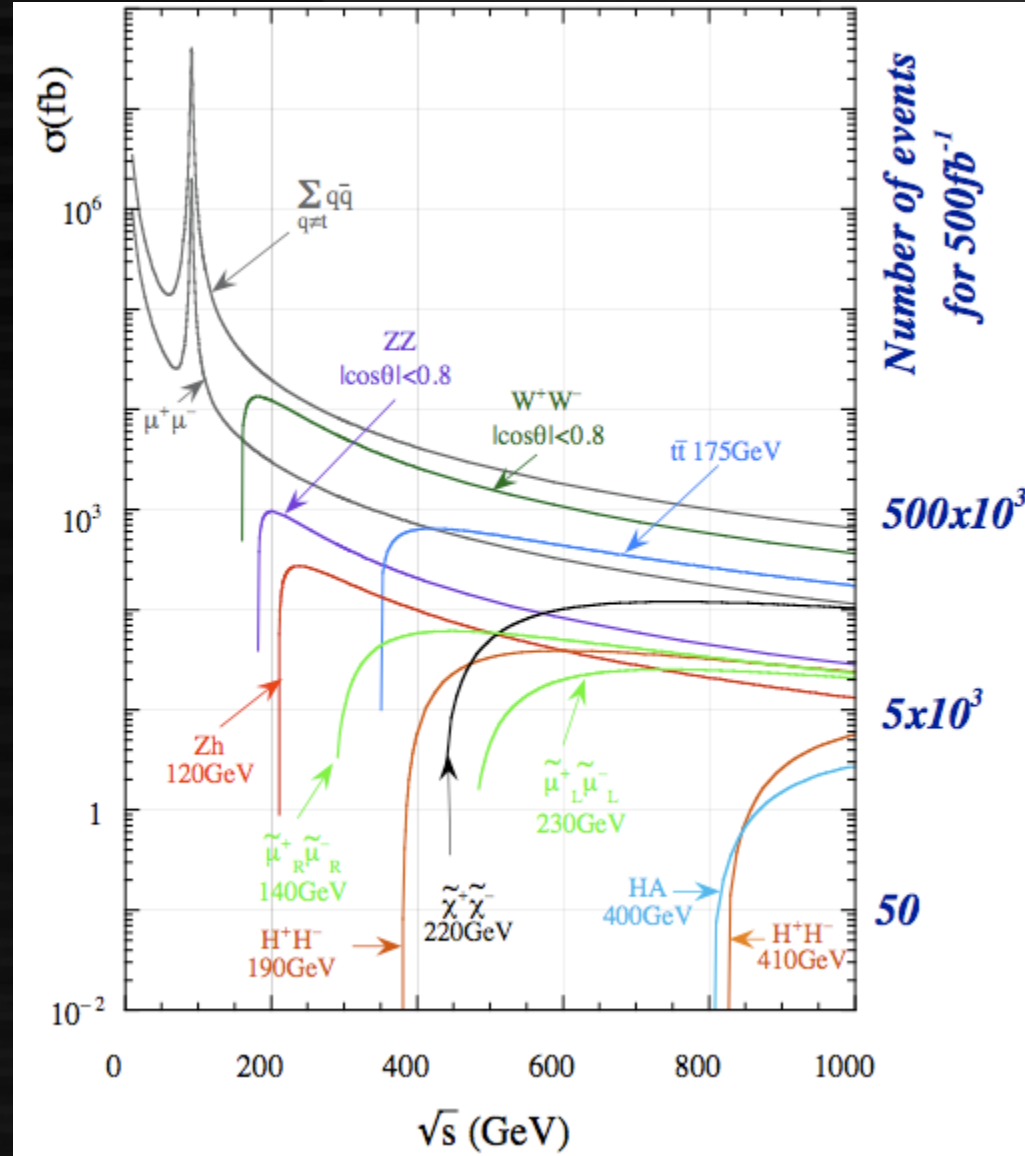


CMS



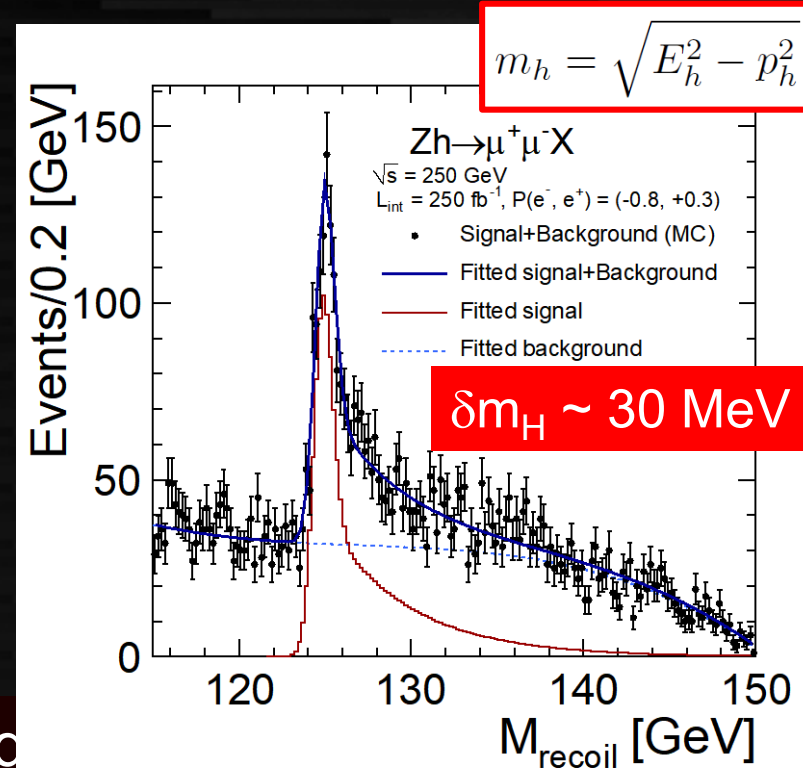
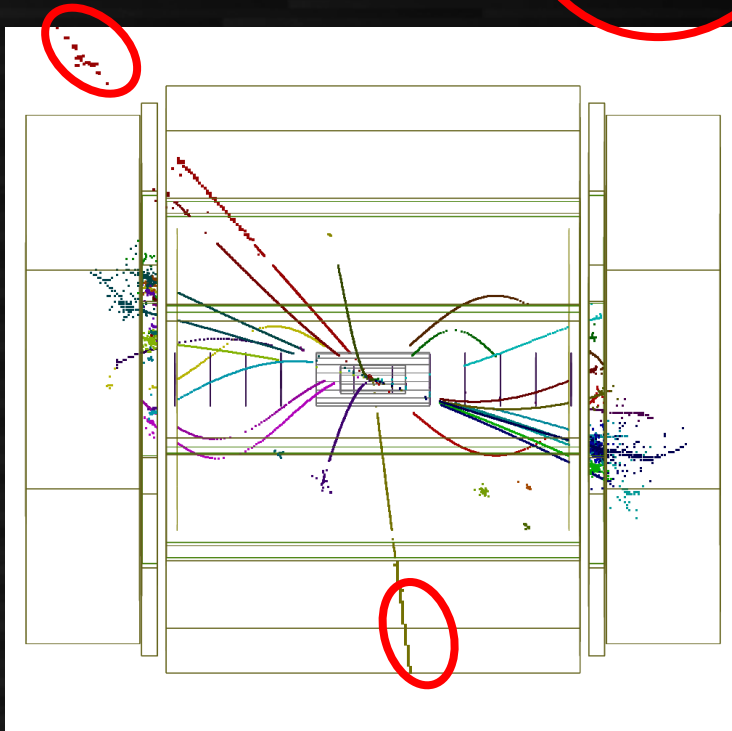
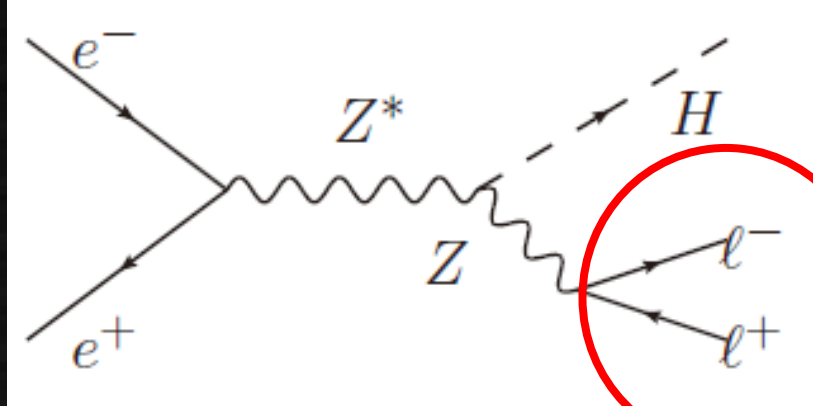
ヒッグスの測定 (2)

- 事象分離
 - 信号事象(ヒッグス)の10~100倍の背景事象がある
 - Z, Hの運動量・エネルギーや生成角、クォークの種類等の情報を駆使して背景と信号を分離する
 - ILCの始状態の4元運動量は明確



ヒッグス反跳質量測定

- “Higgsを見るのにHiggsを見ない”
→ 反跳されるZ → llのみを使う
(4-momentum conservation)
- “Higgsを見ない”のでどんな崩壊でも関係なく見える
→ ヒッグスの性質に依存しない



ヒッグスの結合定数測定

- 各崩壊の事象数を高精度測定

– 精度:

$$\frac{\sqrt{S + N}}{S}$$

S: 信号事象数

N: 背景事象数

テキスト訂正

– 1万事象、背景なしで1%統計誤差

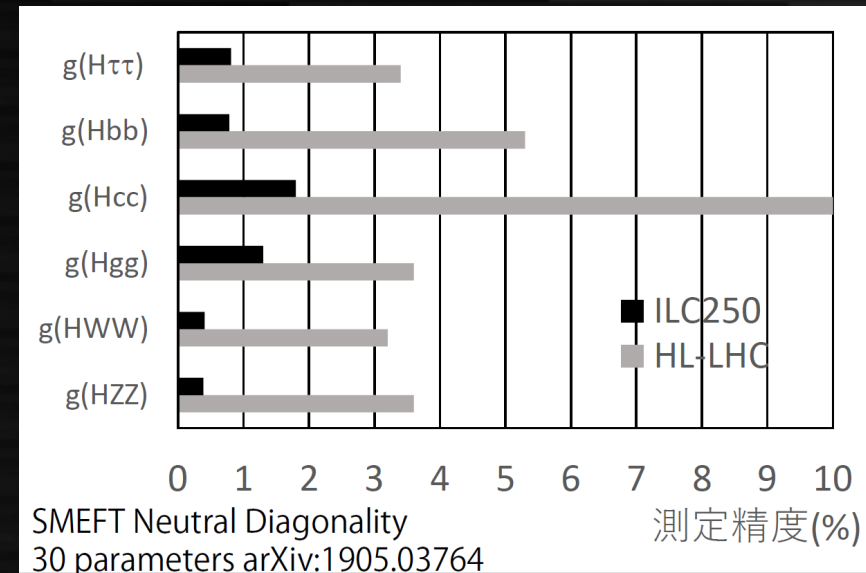
– 1万事象、背景10万で3%統計誤差

- 精度: 統計誤差と系統誤差による。

電子陽電子コライダーは
理論予測の精度が高く
系統誤差も1%以下に
抑えられる。

ILCでは概ね1%以下の精度
で各結合定数を決定する。

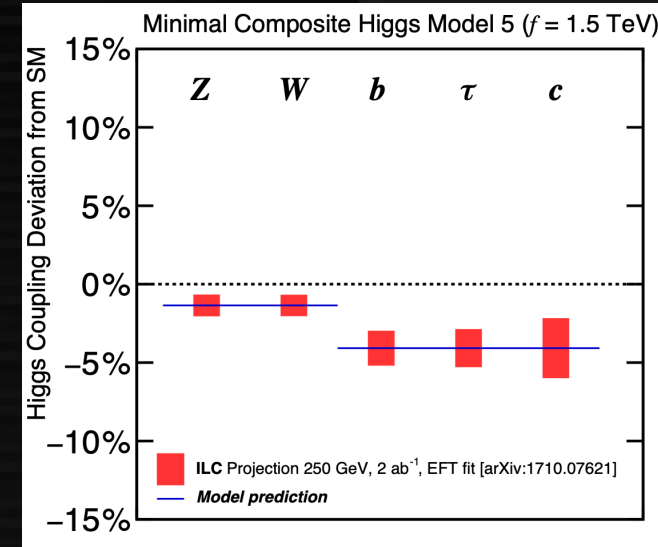
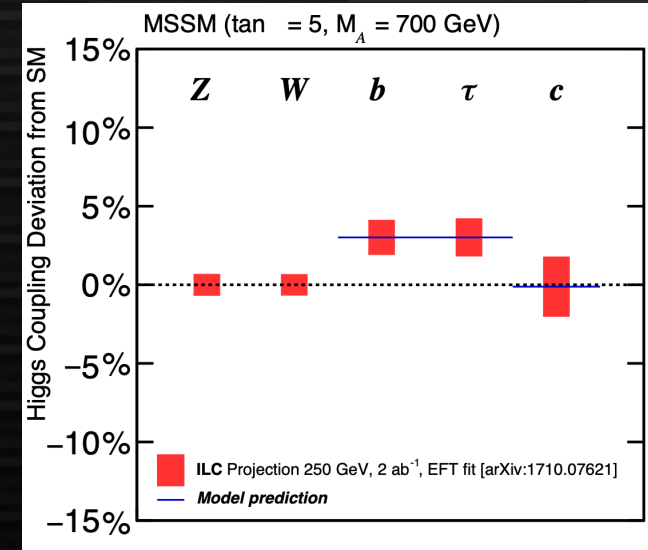
崩壊モード	崩壊分岐比	ILC 事象数
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ヒッグス結合定数による新物理探索

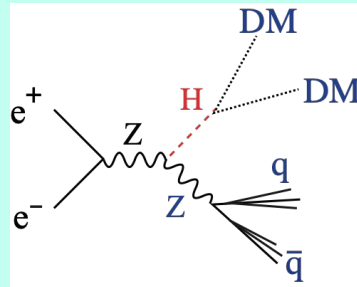
- ヒッグスの結合定数の標準理論からのずれが発見できれば、そのパターンから新物理を区別できる。
 - SUSY: b/τ の結合が上昇
 - 複合ヒッグス: フェルミオンの結合定数が下がる
- ずれが見えるかどうかは新物理のパラメータによるが、
ILCではTeV新物理の多くをカバーする

	ゲージ場との結合	湯川結合			2 HDの質量 与え方パターン	代表的なモデル
	hVV	$h\tau\tau$	hbb	hcc		
	K_V	K_τ	K_b	K_c		
Type-I	↓	↓	↓	↓	νフィリクモデル (H1:SM H2:νへ)	
Type-II	↓	↑	↑	↓	SUSY型	
Type-X	↓	↑	↓	↓	輻射シーソーモデル (μg-2を説明)	
Type-Y	↓	↓	↑	↓	論理的に残された パターン	

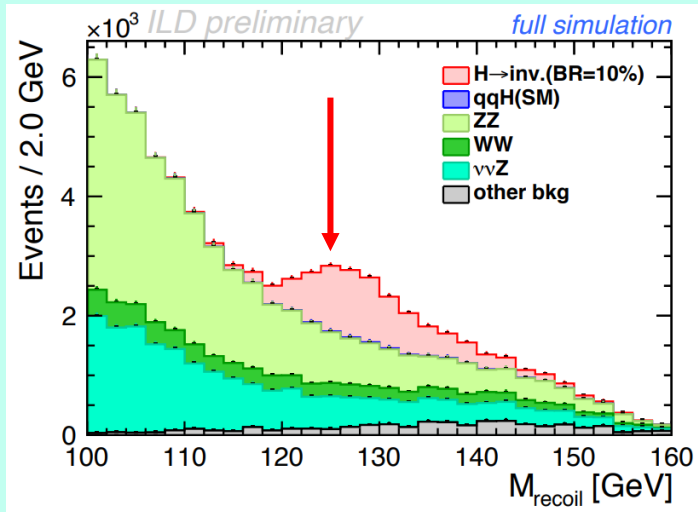


ヒッグスと新粒子の直接結合探索

Higgs Invisible Decays

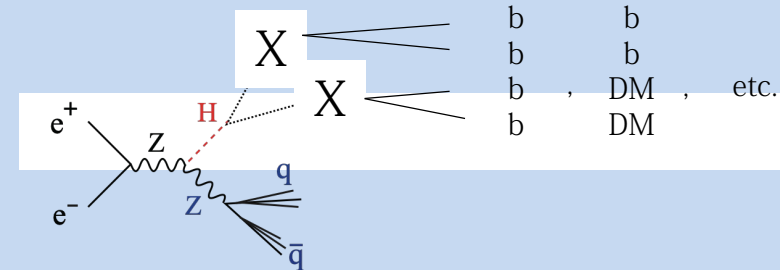


Hadronic Z decay (ILD), Kato, 2002.12048

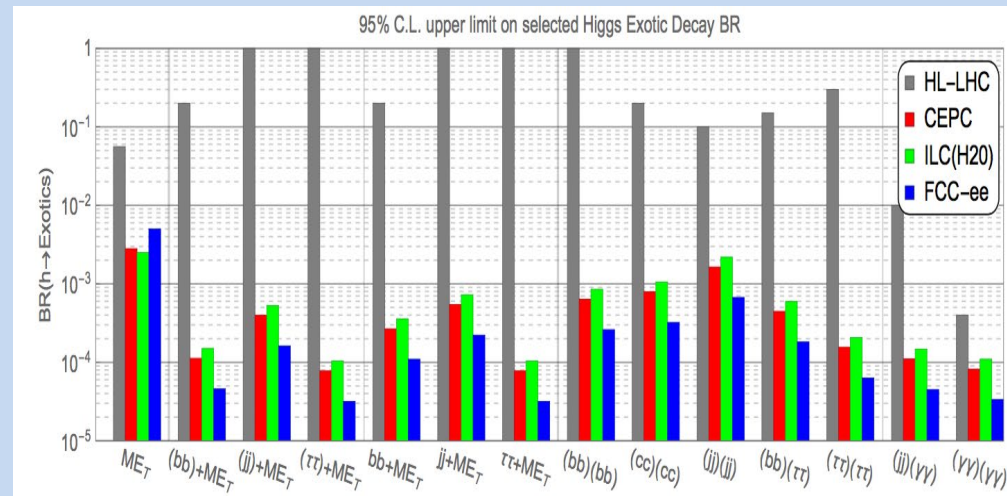


Invisible decay branching ratio: 0.3%
(95% CL upper limit)

Exotic Higgs Decays

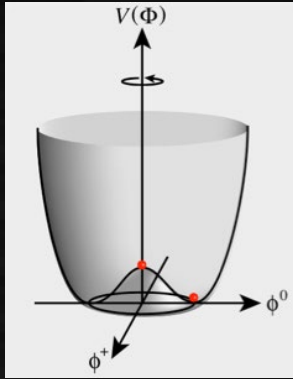


Liu, Wang, Zhang [1612.09284]

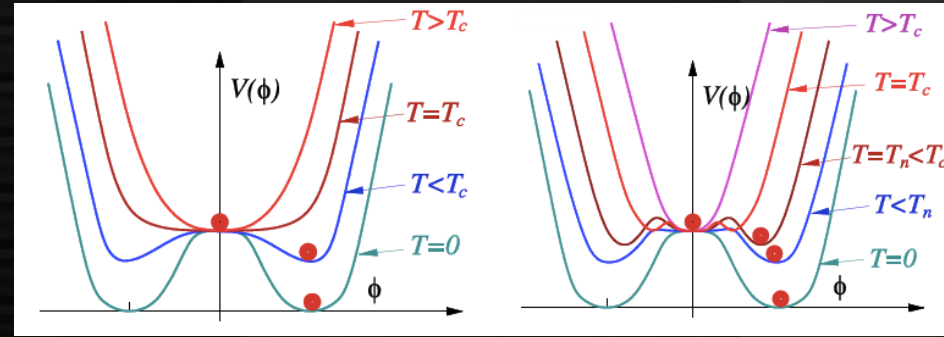


LC sensitive to various exotic Higgs decays

ヒッグス自己結合



ヒッグス
ポテンシャル
の4次の項
真空の構造
を決める



真空の2次相転移

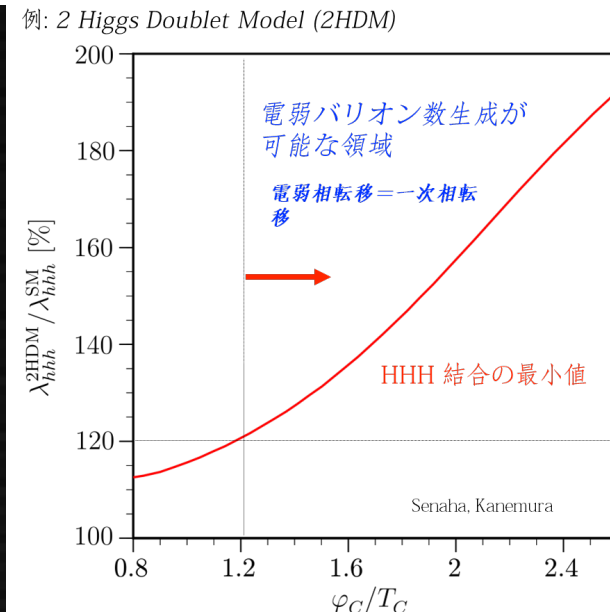
真空の1次相転移

スファロンによる
電弱バリोजェネシス
に必要

$$V(\eta_H) = \frac{1}{2} m_H^2 \eta_H^2 + \lambda v \eta_H^3 + \frac{1}{4} \lambda \eta_H^4$$

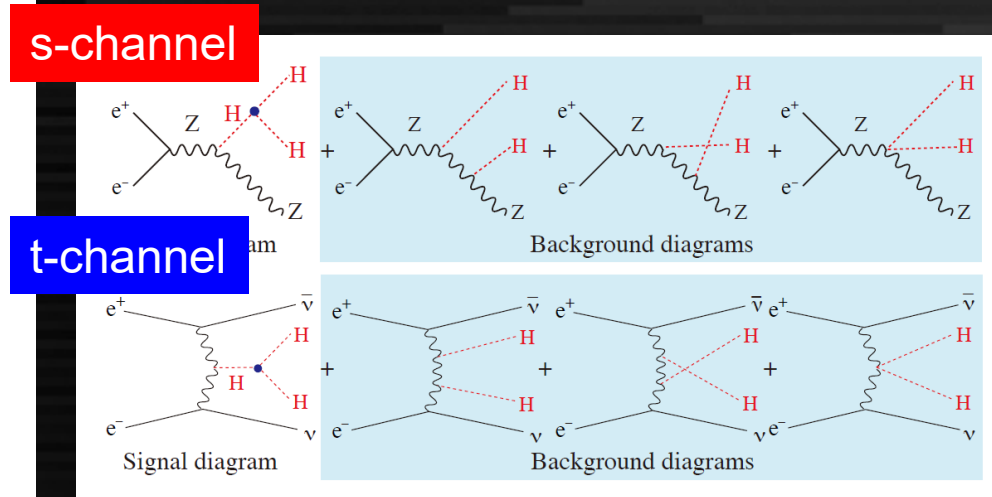
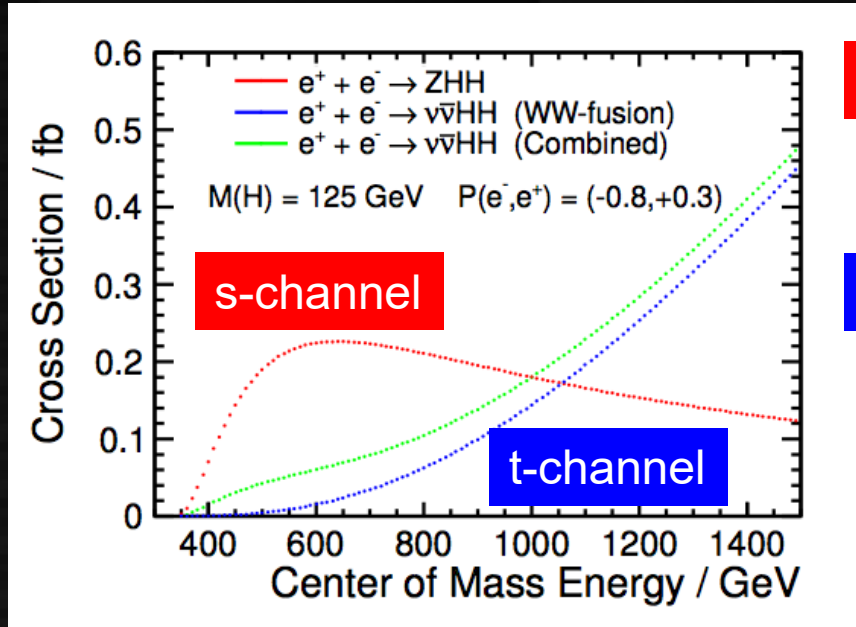
宇宙の物質生成を解き明かす
二つのプローブ

1. **ヒッグスと電弱バリोजェネシス**
 - 真空の一次相転移
2. ニュートリノとレプトジェネシス
 - 重いレプトン崩壊のCP破れ



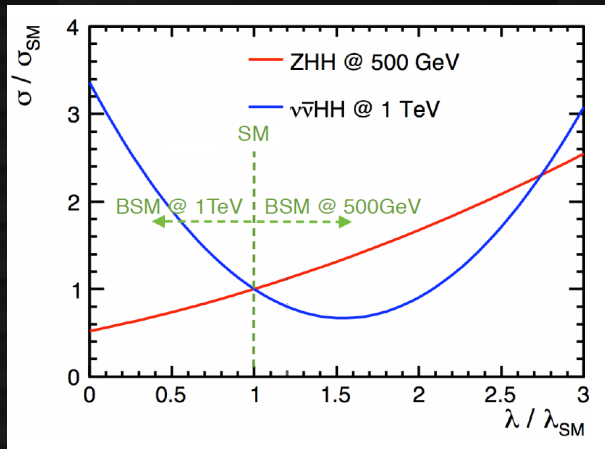
電弱バリオ
ジェネシスなら
λの値は
O(10%)以上
増加する

ヒッグス自己結合@ILC upgrade



干渉項の効果でさらに実質断面積低下

断面積が小さく困難。1 ab^{-1} でO(100)事象



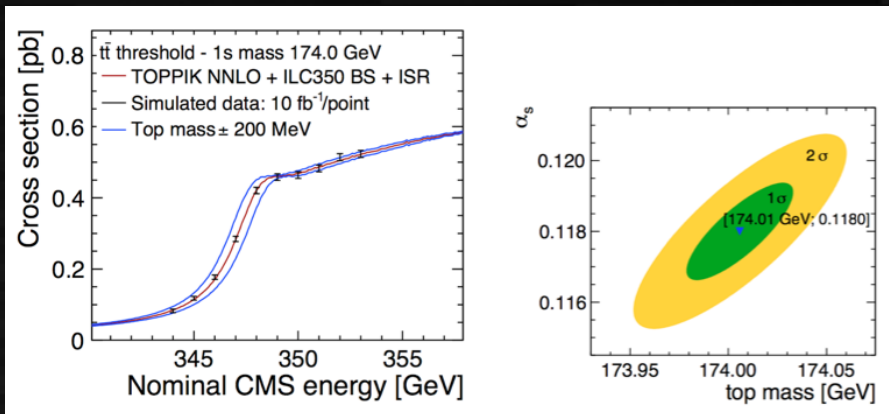
干渉項が3点結合の測定精度に影響
s-channelは正の干渉,
t-channelは負の干渉
(LHCは負の干渉)

channel	\sqrt{s} [GeV]	λ 精度
s (正の干渉)	500-600	~20%
t (負の干渉)	>1000	<10%

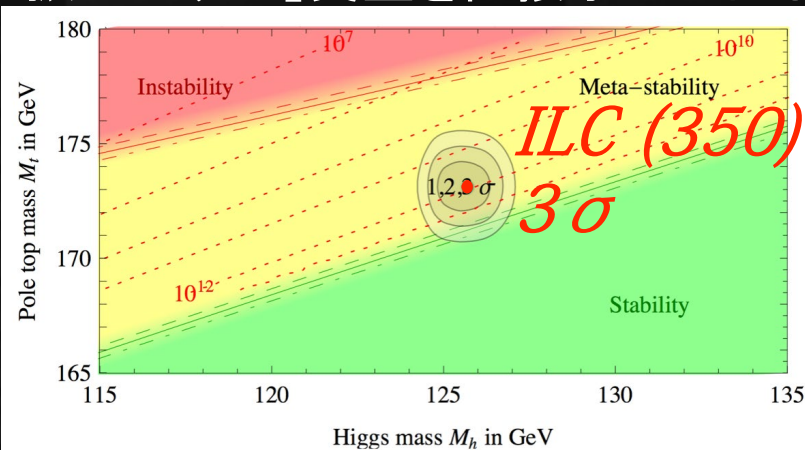
深層学習によるジェット再構成性能の抜本的な改善に取り組んでいる

トップ測定 @ ILC 350 GeV

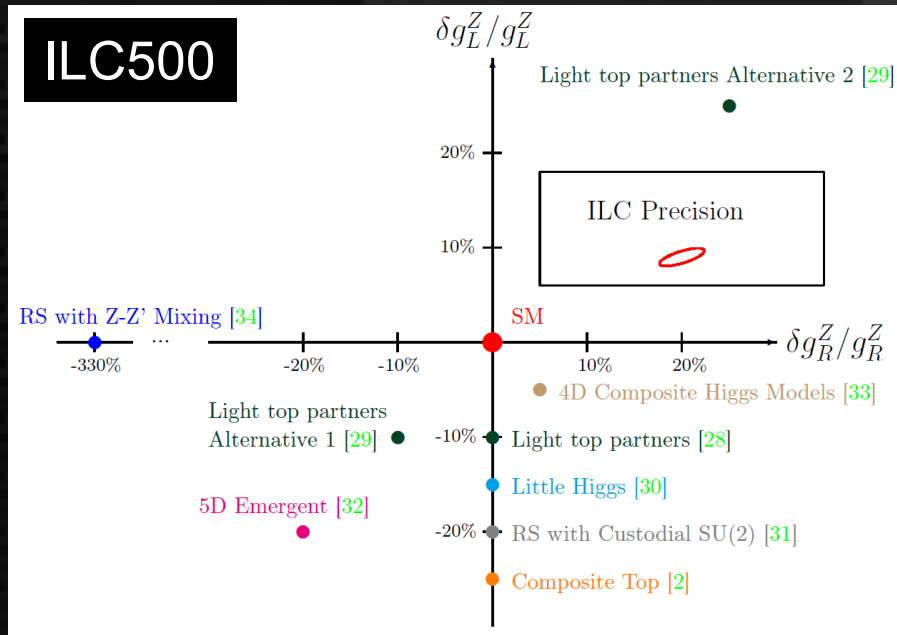
topの精密測定



Threshold scanによるtopの精密測定
MSbarに直接変換できる「理論的に扱いやすい」質量を直接求められる



ILC500



偏極を用いて左巻き、右巻きの結合定数を求め、Topが関係する新物理の探索・モデル識別が可能

$$\Delta m_t(\overline{MS}) \lesssim 50 \text{ MeV}$$

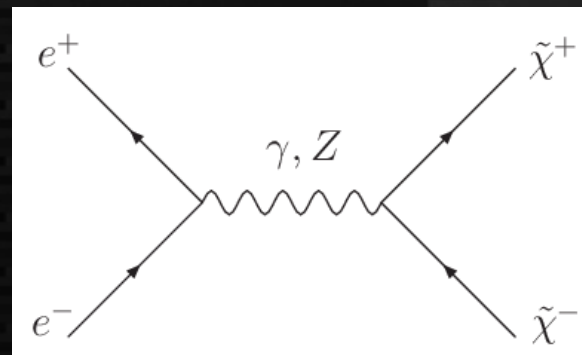
$$\Delta m_h \simeq 14 \text{ MeV}$$

ILCで真空の位置を正確に決定

SUSY直接探索 @ ILC any energy

- SUSY粒子の探し方

- 重い新粒子を対生成
→ LSP (暗黒物質)と
通常の粒子に崩壊
例) $\tilde{\chi}^+ \rightarrow \chi^0 qq$



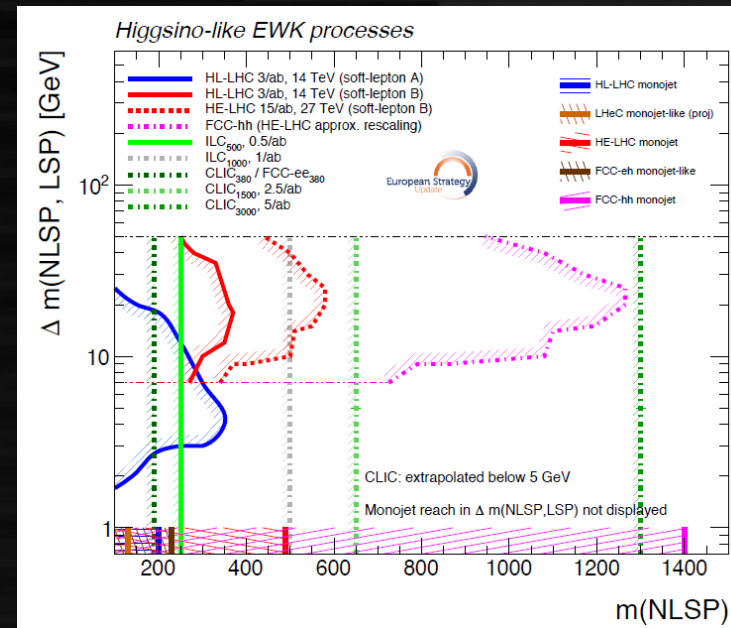
→ $\chi^0 qq$

→ $\chi^0 qq$

- χ^0 は検出不可 (暗黒物質)

- $\tilde{\chi}^+$ と χ^0 の質量差が小さい場合、 qq のエネルギーが小さくなりLHCでは検出困難に
→ Compressed SUSY

- ILCでは検出・精密測定可能

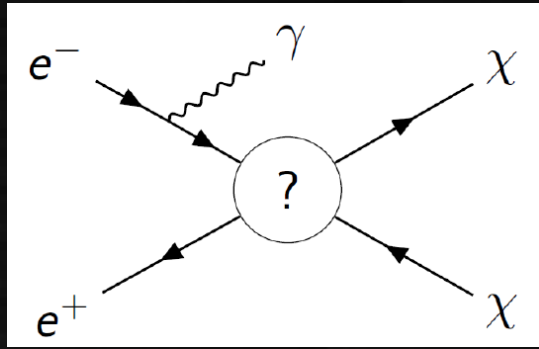


Mono-photon search

arXiv:2001.03011

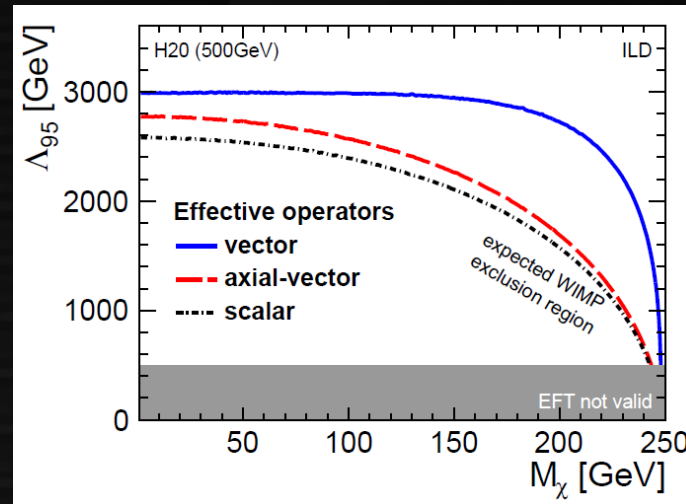
モデル非依存に $m < \sqrt{s}/2$ の
暗黒物質を直接探索

偏極を用いて暗黒物質のスピンの情報が得られる

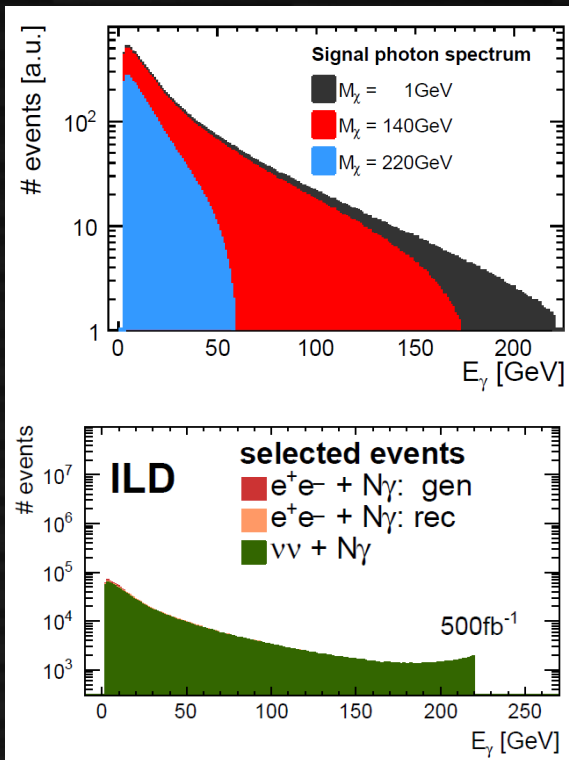


	four-fermion operator	$\sigma(e_L^-, e_R^+) = \sigma(e_R^-, e_L^+)$	$\sigma(e_L^-, e_L^+) = \sigma(e_R^-, e_R^+)$
vector	$(\bar{f}\gamma^\mu f)(\bar{\chi}\gamma_\mu\chi)$	$\sigma \propto 1/\Lambda^4$	0
axial-vector	$(\bar{f}\gamma^\mu\gamma^5 f)(\bar{\chi}\gamma_\mu\gamma_5\chi)$	0	$\sigma \propto 1/\Lambda^4$
scalar	$(\bar{\chi}\chi)(\bar{f}f)$	0	$\sigma \propto 1/\Lambda^4$

Λ は新物理のエネルギースケール



複数の
衝突エネルギー
での測定により
スピン・質量を
さらに感度よく
決定できる



単一光子信号 ~3 TeVスケールの新物理に感度
とバックグラウンド